

IRAM336-025SB3 Information


For Reference Only

Part Number [IRAM336-025SB3](#)
Manufacturer Infineon Technologies
Category Discrete Semiconductor Products
[Power Driver Modules](#)
Description IC HYBRID MULTI-CHIP 500V 2A
Package 19-PowerSSIP Module, Formed Leads
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


IRAM336-025SB3 Specifications

Manufacturer Part Number	IRAM336-025SB3
Manufacturer	Infineon Technologies
Category	Discrete Semiconductor Products Power Driver Modules
Package	19-PowerSSIP Module, Formed Leads
Series	-
Type	MOSFET
Configuration	3 Phase
Current	2A
Voltage	500V
Voltage - Isolation	-
Package / Case	19-PowerSSIP Module, Formed Leads
Report errors?	

IRAM336-025SB3 Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.


Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

IRAM336-025SB3 Payment Methods



IRAM336-025SB3 Shipping Methods



If you have any question about IRAM336-025SB3, please do not hesitate to contact us!

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